

# AN8064SP

## Low Drop-out Voltage Regulator

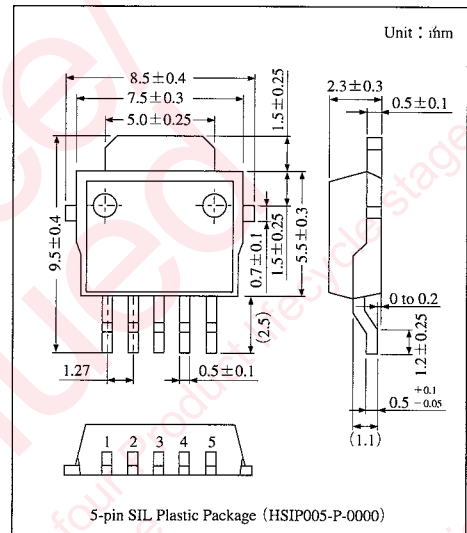
### Overview

The AN8064SP is a voltage regulator IC with strobe pin capable of switching the output ON/OFF.

Its rated load current is 150mA and output voltage is 4V fixed.

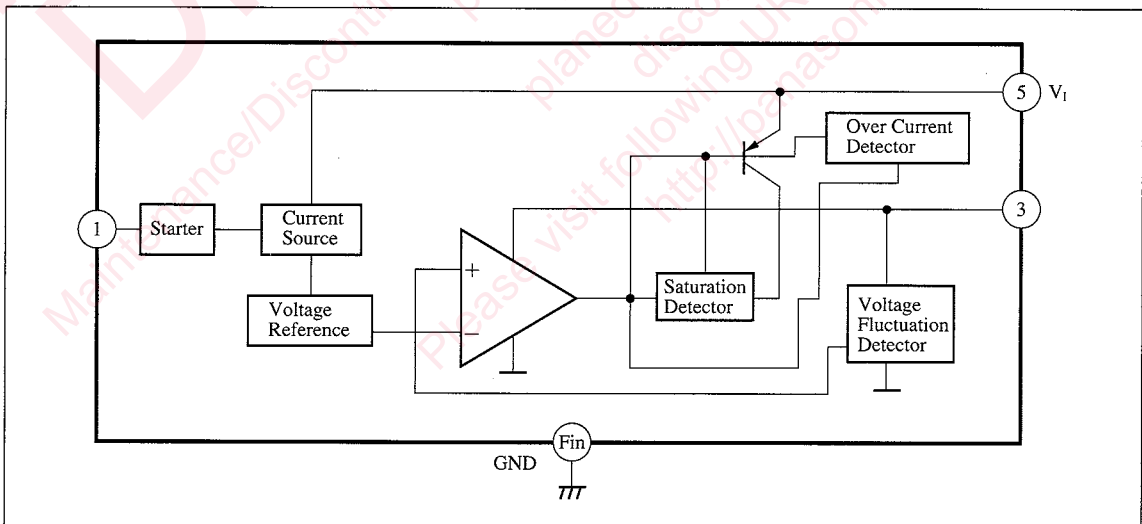
### Features

- 150mA rated load current and 4V fixed output voltage
- Capable of turning off output by setting the strobe pin to the "L" level
- Minimum input/output voltage difference : typ. 0.25V
- Built-in overcurrent protective circuit
- Surface-mount type 5-pin SIL plastic package



Voltage  
Regu-  
lators

### Block Diagram



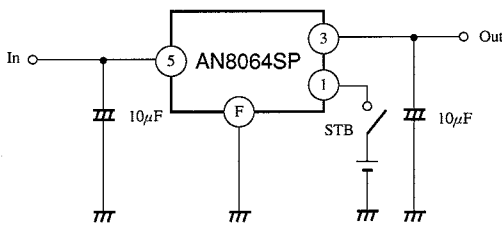
■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply voltage	V <sub>I</sub>	14.4	V
Power dissipation	P <sub>D</sub>	500	mW
Operating ambient temperature	T <sub>opr</sub>	-20 to +75	°C
Storage temperature	T <sub>stg</sub>	-55 to +125	°C

■ Electrical Characteristics (Ta=25°C)

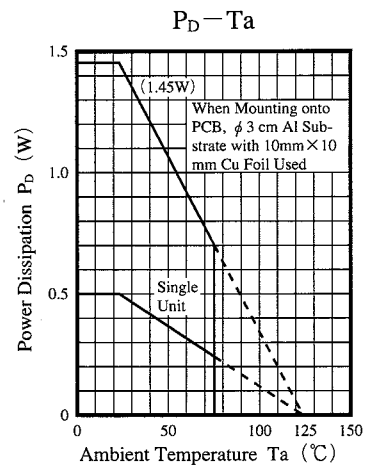
Parameter	Symbol	Condition	min	typ	max	Unit
Output voltage	V <sub>O</sub>	V <sub>I</sub> =12V, I <sub>O</sub> =150mA	3.84	4	4.16	V
Output voltage range	V <sub>i</sub>	V <sub>I</sub> =5 to 14.4V, I <sub>O</sub> =0 to 150mA	3.76	4	4.24	V
Bias current at no load	I <sub>bias</sub>	V <sub>I</sub> =11V, I <sub>O</sub> =0mA	—	2.9	4	mA
Load regulation	REG <sub>L</sub>	V <sub>I</sub> =11V, I <sub>O</sub> =0 to 150mA	—	—	100	mV
Line regulation	REG <sub>IN</sub>	V <sub>I</sub> =5 to 13V, I <sub>O</sub> =150mA	—	—	100	mV
Minimum input/output voltage difference	V <sub>DIF(min)</sub>	V <sub>I</sub> =3.5V, I <sub>O</sub> =150mA	—	—	0.6	V
Rush current	I <sub>rush</sub>	V <sub>I</sub> =3.5V, I <sub>O</sub> =0mA	—	2.5	—	mA
Output short-circuit current	I <sub>O(short)</sub>	V <sub>I</sub> =11V	350	—	550	mA
Load bias current fluctuation	ΔI <sub>bias</sub>	V <sub>I</sub> =11V, I <sub>O</sub> =0 to 150mA	—	—	10	mA
Off-state bias current	I <sub>OFF</sub>	V <sub>I</sub> =11V, V <sub>S</sub> =0V	—	—	2	μA
Strobe pin input current	I <sub>S</sub>	V <sub>I</sub> =11V, V <sub>S</sub> =2.5V	—	—	200	μA
Strobe pin threshold voltage	V <sub>S(TH)</sub>	V <sub>I</sub> =11V	0.8	2	2.4	V
Ripple rejection ratio	RR	V <sub>I</sub> =9 to 13V, I <sub>O</sub> =150mA, f=120kHz	—	55	—	dB

■ Application Circuit



- When using at a low temperature, it is recommended to use capacitors with a low internal impedance (for example, tantalum capacitors) for output capacitors.

■ Characteristics Curve



## Request for your special attention and precautions in using the technical information and semiconductors described in this book

- (1) If any of the products or technical information described in this book is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially, those with regard to security export control, must be observed.
- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products. No license is granted in and to any intellectual property right or other right owned by Panasonic Corporation or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information described in this book.
- (3) The products described in this book are intended to be used for standard applications or general electronic equipment (such as office equipment, communications equipment, measuring instruments and household appliances).  
Consult our sales staff in advance for information on the following applications:
  - Special applications (such as for airplanes, aerospace, automobiles, traffic control equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
  - Any applications other than the standard applications intended.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.
  - Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of our company.